

3.2mmx1.6mm SMD CHIP LED LAMP

# Features

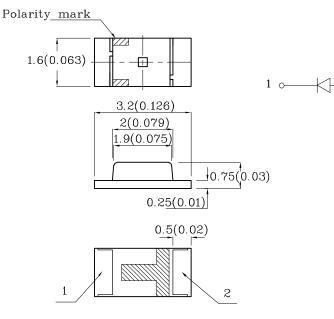
- $\bullet$  Ideal for indication light on hand held products
- $\bullet$  Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- $\bullet$  RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

# Package Schematics





1. All dimensions are in millimeters (inches).

2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Green (AlGaInP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	$\mathbf{P}_{\mathrm{D}}$	75	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	-0	

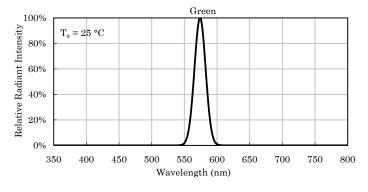
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)		Green (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.1	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V	
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA	
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λP	574*	nm	
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I <sub>F</sub> =20mA)	λD	570*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle\lambda$	20	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	pF	

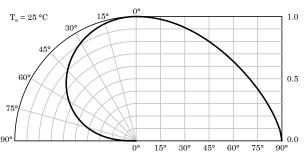
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =20mA) mcd		Wavelength CIE127-2007* λPnm	Viewing Angle 20 1/2
				min.	typ.		
XZVG55W-1	Green	AlGaInP	Water Clear	20*	49*	574*	140°

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

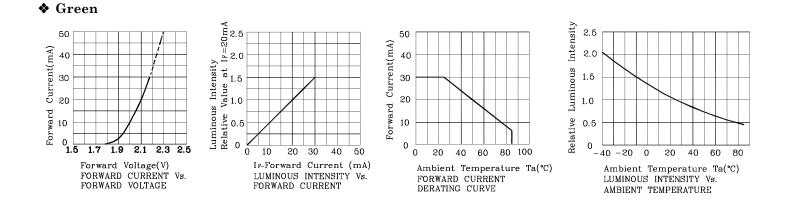




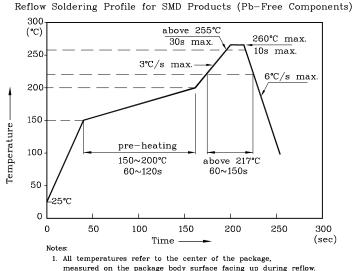
Relative Intensity Vs. CIE Wavelength



Spatial Distribution



### LED is recommended for reflow soldering and soldering profile is shown below.



### measured on the package body surface facing up during reflow.

2. Do not apply any stress to the LED during high temperature conditions 3. Maximum number of soldering passes: 2

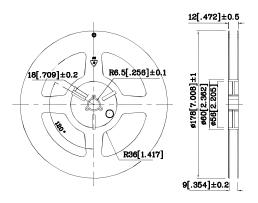


♦ The device has a single mounting surface. The device must be mounted according to the specifications.

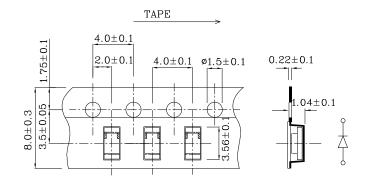
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



# ✤ Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

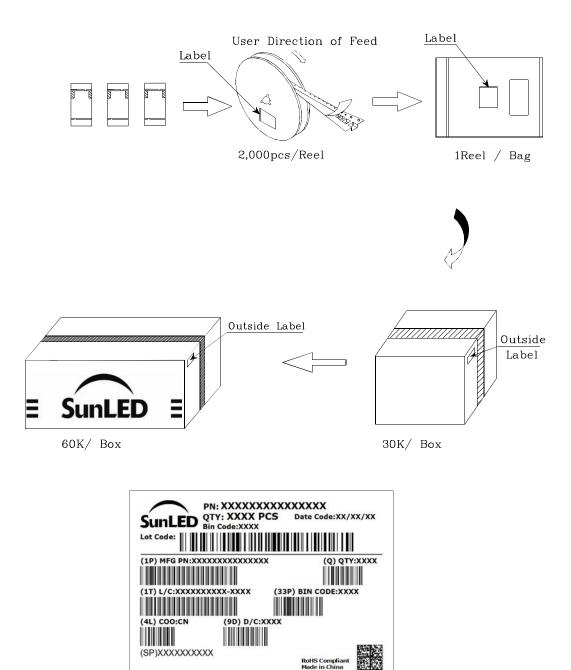
3. Forward Voltage: +/-0.1V  $\,$ 

Note: Accuracy may depend on the sorting parameters.

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### **PACKING & LABEL SPECIFICATIONS**



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